SIEX SWhen it Absolutely Must Connect

# Dual-band Wi-Fi 6 plus Bluetooth® Combo SDIO Module

SX-SDMAX-2530S

technology

# Low Power Wireless LAN Module Powered by NXP's IW611

# Overview

The SX-SDMAX is a Wi-Fi 6 (IEEE 802.11a/b/g/n/ac/ax) plus Bluetooth<sup>®</sup> v5.3 that supports SDIO as its host interface. Powered by NXP's highly integrated IW611 chipset, the Wi-Fi 6 module delivers higher throughput, better network efficiency, lower latency, and improved range over previous-generation Wi-Fi standards. The module supports SDIO as its host interface, which is a popular choice for many battery-operated device applications, as it provides the perfect balance between performance and power consumption. In addition, by supporting a wide temperature range, it is a wireless LAN module that is ideal for wireless compatibility with a wide range of products, from industrial equipment to small devices.

# Efficient, Faster, & Lower Latency with Wi-Fi 6

The latest Wi-Fi 6 technology introduces features such as OFDMA, 1024QAM, and Target Wake Time (TWT) bringing higher throughput, better network efficiency, lower latency, and improved range over previous-generation Wi-Fi standards.

The SX-SDMAX with its SDIO host interface combines all the benefits of Wi-Fi 6 while optimizing power consumption to deliver unmatched Wi-Fi performance with improved battery life, making it an ideal solution for many battery-operated embedded devices.

# Wi-Fi 6 Features

1 Efficiency MU-MIMO OFDMA Improved efficiency and stability in dense networks. Wi-Fi 6 delivers data reliably with low latency even in congested radio wave environments.

#### 2 Power Saving TWT Multiple BSS

Wi-Fi 6 has introduced new features like Target Wake Time which allows devices to negotiate when and how frequently they will wake up to send or receive data. This Wi-Fi 6/6E feature increases device sleep time and greatly improves battery life. It also incorporates a mechanism for avoiding collisions between packets and for efficiently avoiding radio wave interference for efficient communication.

# SX-SDMAX Features

- PHY data rate up to 600Mbps (at 5GHz/80MHz/MSC11)
- Single stream, 1x1
- Powered by NXP's IW611 chipset
- Host interface: Wireless LAN SDIO3.0 compatible, Bluetooth<sup>®</sup> UART
- 80MHz band mode (5GHz)
- High density modulation mode (1024 QAM)
- Bluetooth<sup>®</sup> v5.3 Class1 compatible
- RoHS compliant
- Modular certifications(Planned) : Japan, USA, Canada, Europe, UK

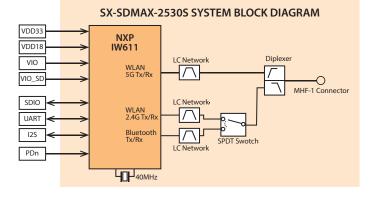
# Applications

Ideal for many battery operated medical devices, mobile printers, Hand held POS and terminals, barcode scanners, IoT Applications etc.

# Specifications

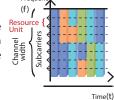
Product Name	SX-SDMAX-2530S				
Chipset	NXP IW611				
Host Interface	WLAN : SDIO3.0 Bluetooth® : UART				
Wi-Fi Standard	IEEE 802.11a/b/g/n/ac/ax (1x1)				
Bluetooth®	Bluetooth® v5.3 (BR/EDR/LE Compliant)				
Antenna Connector	MHF Connector :1				
Operating Voltage	Main Power Supply :3.3V + 1.8V IO Power Supply:1.8V or 3.3V				
Current Consumption (Peak Value)	Voltage	VDD18		VDD33	
		Тx	Rx	Tx	Rx
	Wi-Fi:2.4GHz	190mA	130mA	200mA	10mA
	Wi-Fi:5GHz	260mA	150mA	240mA	10mA
	Bluetooth®	150mA	80mA	20mA	10mA
<b>Operating Environment</b>	Temperature : -40 ~ 85°C Humidity : 95% RH or less (Without Condensation)				
Storage Environment	Temperature : -40 ~ 85°C Humidity : 95% RH or less (Without Condensation)				
Size	17.0×18.0×2.65mm				
Weight	1.7g				
Package Type	44-pins Land Grid Array (Direct Solder)				

# Block Diagram











# Dual-band Wi-Fi 6 plus Bluetooth<sup>®</sup> Combo SDIO Module

# SX-SDMAX-2530S

# **Product Lineup**





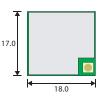
SX-SDMAX-2530S (44pins Direct Solder Pads)

SX-SDCAX-2530 (Micro SD Card Type)

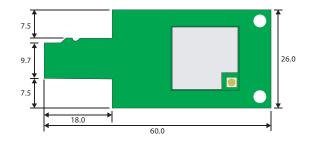
Model	Form Factor	MoQ	Packaging
SX-SDMAX-2530S	Surface Mount	500	Reel
SX-SDMAX-2530S-SP	Surface Mount	1	Reel
SX-SDCAX-2530	Micro SD Card	1	Individual Box

### **Mechanical Drawing**

# SX-SDMAX-2530S



#### SX-SDCAX-2530



#### Wireless Driver <sup>\*\*1</sup>

### [WLAN]

# Linux

- Station, Access Point Mode
- WPA<sup>™</sup>/WPA2<sup>™</sup>/WPA3<sup>™</sup> Authentication
- IEEE 802.1X(TLS, TTLS, PEAP, LEAP, FAST)
- WPS2.0 Support\*2
- Wi-Fi Direct® Support\*2

#### 【Bluetooth®】

 In order to support the Bluetooth<sup>®</sup> v5.3 standard, it is necessary to combine a stack and profile that support the Bluetooth<sup>®</sup> v5.3 standard.

Please contact our sales representative for compatible Bluetooth<sup>®</sup> stacks and profiles.

\*1 : Please contact our sales representative for details of compatible drivers.

\*2 : When using, it is necessary to obtain Wi-Fi Alliance certification separately.

### Evaluation

Although the NXP i.MX BSP will already include Wi-Fi drivers for SX-SDMAX to enable plug-n-play evaluation, Silex also provides a separate evaluation Linux OS image which not only includes Silex's optimized driver but also board data files, and other Linux test tools ideal for evaluation.

#### What you will need?

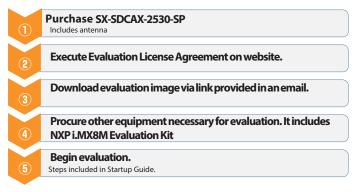
 SX-SDCAX-2530
NXP i.MX8M Evaluation Kit (MCIMX8M-EVKB)



#### Other useful tools inluded in Silex image :

- · Wireless LAN management command iw
- · Throughput test iperf
- · Station/AP function hostapd, wpa\_supplicant
- ·DHCP udhcpd、udhcpc

#### To get started:



#### [SX-SDMAX Product Page]

https://www.silextechnology.com/connectivity-solutions/embedded-wireless/sx-sdmax



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Bluetooth is a trademark or registered trademark of Bluetooth SIG, Inc., USA.
Specifications are subject to change without notice for improvement. The listed specifications are as of March 2023.



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